



## Material Content Data Sheet



<b>Sales Product Name</b>		BTT6050-1EKA		<b>Issued</b>		22. January 2018		
<b>MA#</b>		MA001618312						
<b>Package</b>		PG-DSO-14-47		<b>Weight*</b>		150.23 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.990	1.32	1.32	13247	13247
leadframe	inorganic material	phosphorus	7723-14-0	0.017	0.01		115	
	non noble metal	zinc	7440-66-6	0.069	0.05		460	
	non noble metal	iron	7439-89-6	1.383	0.92		9209	
	non noble metal	copper	7440-50-8	56.175	37.39	38.37	373928	383712
wire	non noble metal	copper	7440-50-8	0.483	0.32	0.32	3214	3214
encapsulation	organic material	carbon black	1333-86-4	0.171	0.11		1137	
	plastics	epoxy resin	-	7.859	5.23		52314	
	inorganic material	silicondioxide	60676-86-0	77.394	51.53	56.87	515177	568628
leadfinish	non noble metal	tin	7440-31-5	2.503	1.67	1.67	16658	16658
plating	noble metal	silver	7440-22-4	1.470	0.98	0.98	9787	9787
glue	plastics	epoxy resin	-	0.125	0.08		832	
	noble metal	silver	7440-22-4	0.589	0.39	0.47	3922	4754
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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